

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
Name	Execution Date
Matthias Lehr	09/21/2009
Frank Koschinsky	09/22/2009
Joerg Hohage	09/21/2009
<b>RECEIVING PARTY DATA</b>	
Name:	GLOBALFOUNDRIES Inc.
Street Address:	Maples Corporate Services Limited
Internal Address:	PO Box 309, Ugland House
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
Postal Code:	KY1-1194
<b>PROPERTY NUMBERS Total: 1</b>	
Property Type	Number
Application Number:	12561701
<b>CORRESPONDENCE DATA</b>	
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Address Line 4:	Houston, TEXAS 77042
ATTORNEY DOCKET NUMBER:	2000.169900
NAME OF SUBMITTER:	J. Mike Amerson
Total Attachments: 2	
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**PATENT**  
**REEL: 023327 FRAME: 0444**



ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, do hereby:

SELL, ASSIGN AND TRANSFER to GLOBALFOUNDRIES Inc. (the "Assignee"), having a business address of Maples Corporate Services Limited, PO Box 309, Ugland House, Grand Cayman KY1-1194, Cayman Islands, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements which are disclosed in the application for United States Letters Patent, Serial No. 12/561,701, filed September 17, 2009, entitled **REDUCED WAFER WARPAGE IN SEMICONDUCTORS BY STRESS ENGINEERING IN THE METALLIZATION SYSTEM**, such application and all divisional, continuing, substitute, renewal, reissuance and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for vesting title to such improvements in the Assignee, and for securing, maintaining and enforcing proper patent protection for such improvements;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Signature:   
MATTHIAS LEHR

Date: 21 Sept 2009

WITNESSES FOR MATTHIAS LEHR:



Date: 21.9.2009




Date: 21.9.2009

Signature:   
FRANK KOSCHINSKY

Date: 22 Sept 2009

WITNESSES FOR FRANK KOSCHINSKY:



Date: 22 Sept 2009

K. Gluck

Date: 22. 09. 09

Signature:   
JOERG HOHAGE

Date: 21 Sept 2009

WITNESSES FOR JOERG HOHAGE:



Date: 22 Sept 2009

K. Gluck

Date: 22. 09. 09